

Modification de matériaux semi-transparents par lasers à impulsions ultra-brèves

Modification of semi-transparent materials by ultra-short pulse lasers

Pol Sopeña

LP3 - Lasers, Plasmas et Procédés Photoniques (UMR 7341)

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Pre-doc (Universitat de Barcelona)



UNIVERSITAT DE
BARCELONA

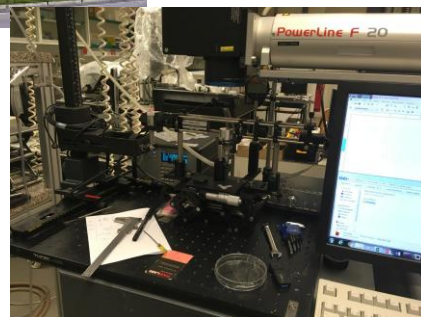
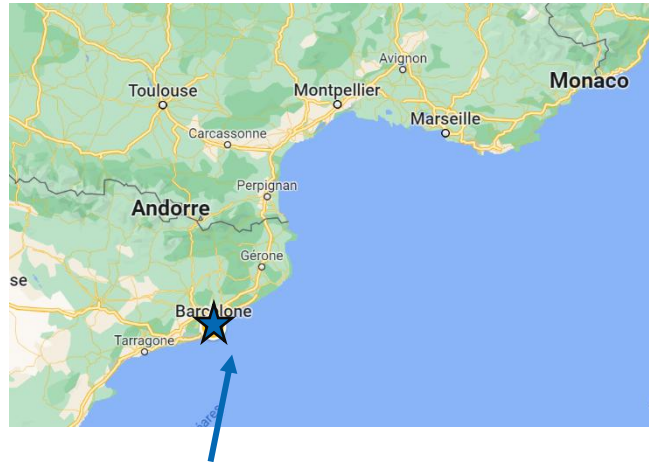
Dep. Física Aplicada

2010-2014

Physics Bachelor

2014-2015

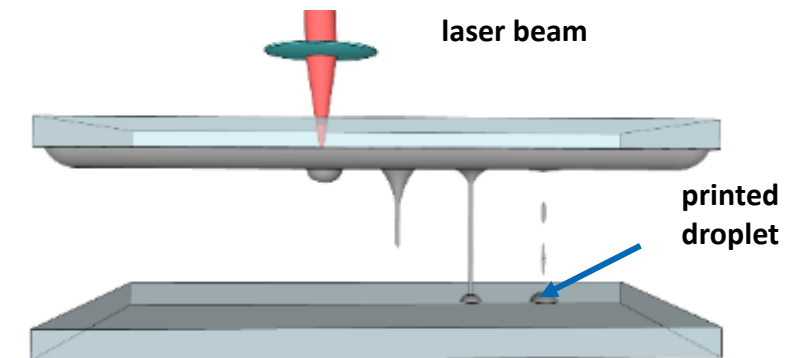
Advanced Physics Master



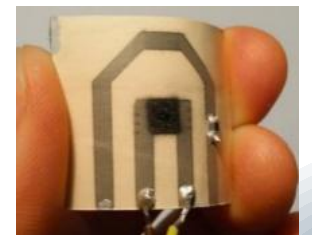
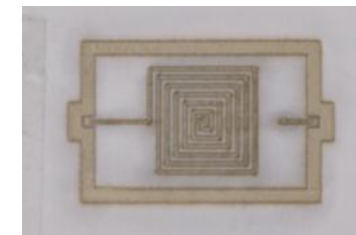
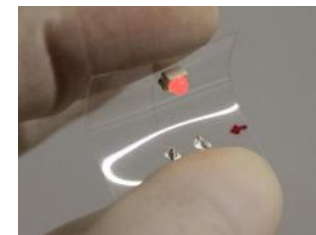
PhD program (Universitat de Barcelona)

2015-2020

Laser-induced forward transfer



printed electronics components



Post-doc → Chargé de Recherche (Aix-Marseille Université - CNRS)

2021-2024



Laboratoire LP3
(Lasers, Plasmas et Procédés Photoniques)

- ERC Project (2021-2022)
- Margarita Salas (2022)
- CIVIS3i MSCA (2022-2024)



2024-present

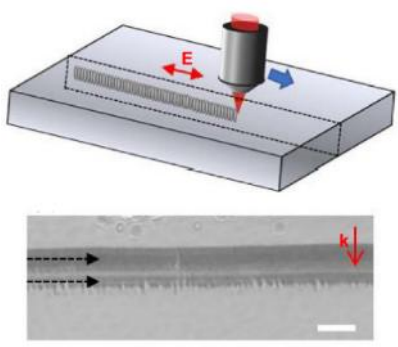


Chargé de Recherche CNRS
(Permanent research fellow)

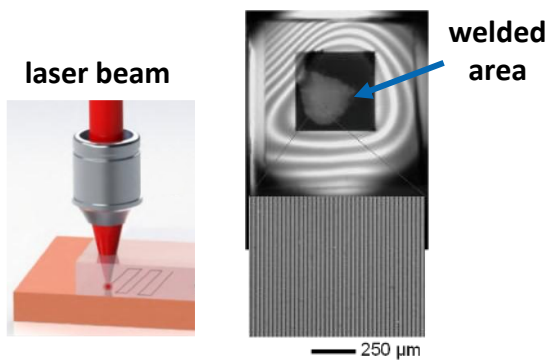


Infrared and ultrafast laser processing

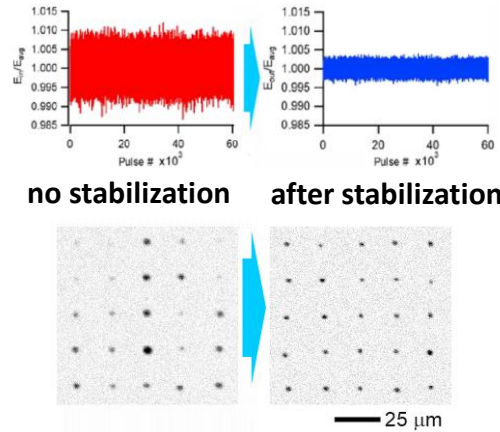
bulk Si and GaAs modification



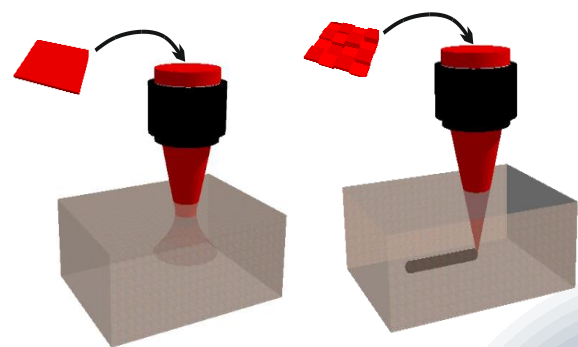
semiconductor laser welding



nonlinear precision enhancement



processing of scattering materials



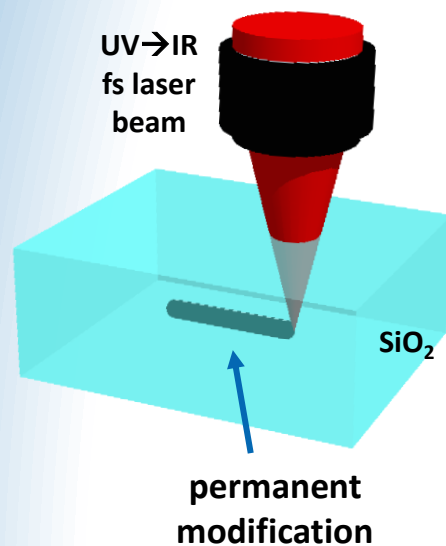
Dielectrics

Silica (SiO_2)

- Bandgap: 9.0 eV
- n: 1.45

Ultrashort pulses in dielectrics

- Femtosecond pulses ($\sim 10^{-13}$ s)
- Extreme intensities ($\sim 10^{15}$ W/cm²)
- Multiphoton absorption



Semiconductors

Silicon (Si)

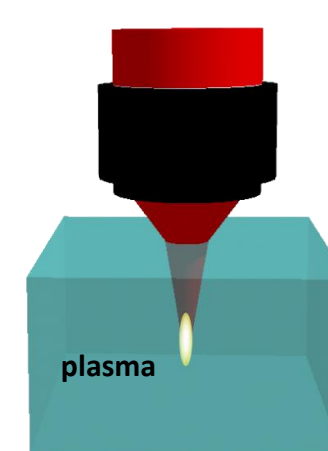
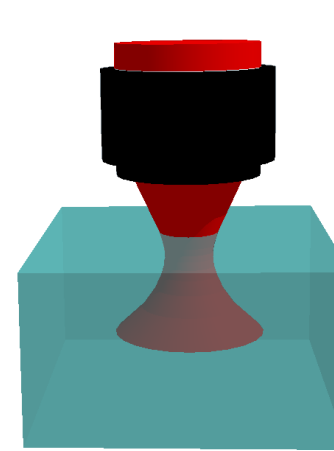
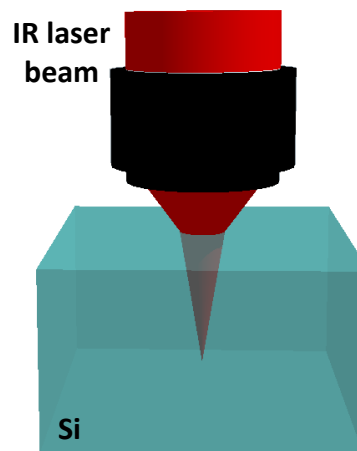
- Bandgap: 1.1 eV
- n: 3.5

Gallium Arsenide (GaAs)

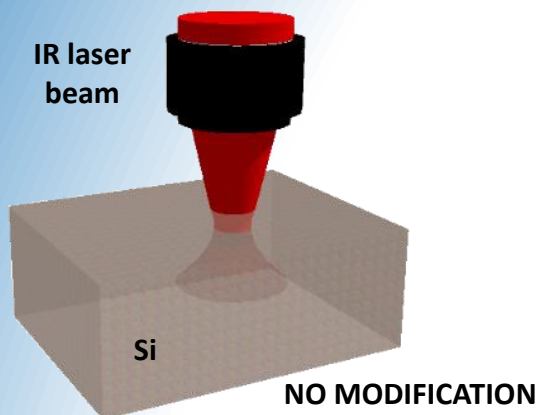
- Bandgap: 1.4 eV
- n: 3.4

Ultrashort pulses in semiconductors → 2-3 photon absorption (near-IR)

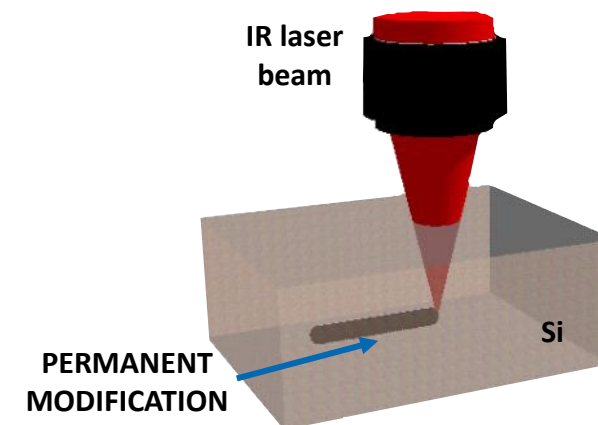
- Reduced numerical aperture (high n)
- Beam defocusing (nonlinear propagation)
- Pre-focal plasma (screening)



Semiconductors

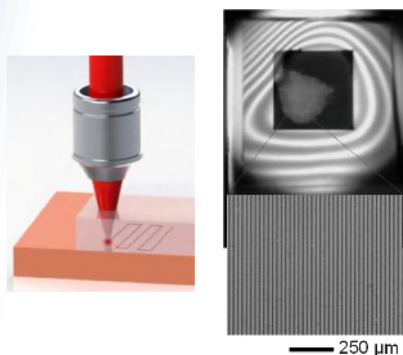


Compensation strategies

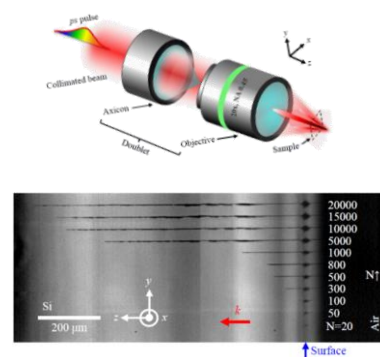


Temporal strategies

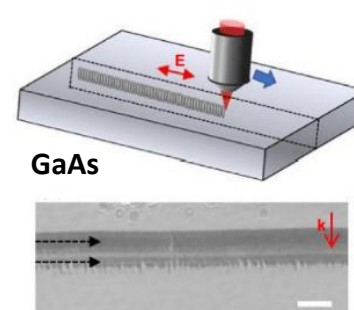
nanosecond pulses



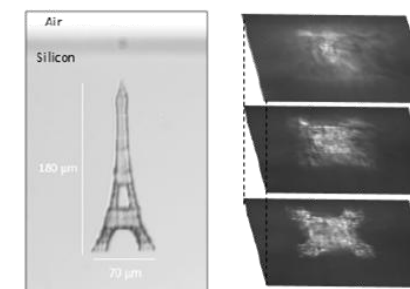
picosecond pulses



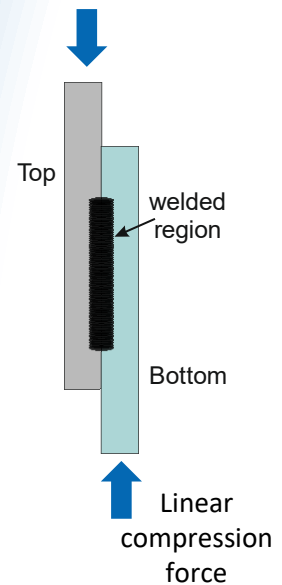
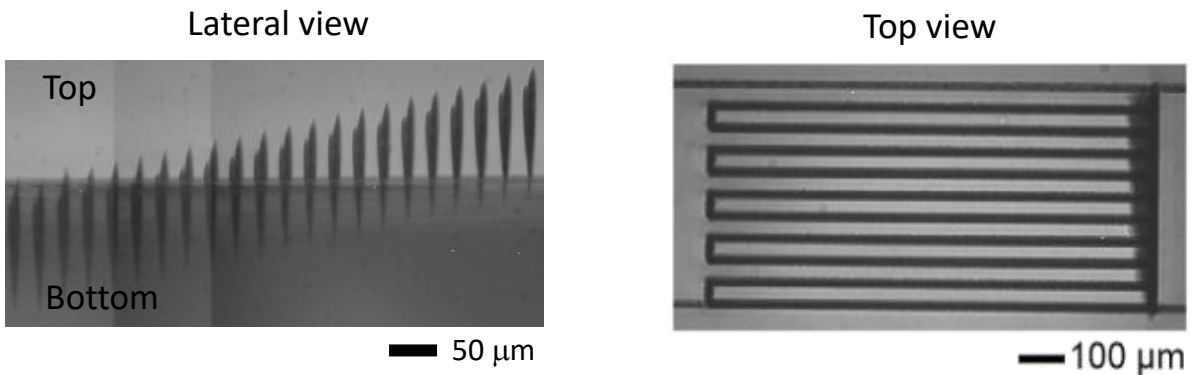
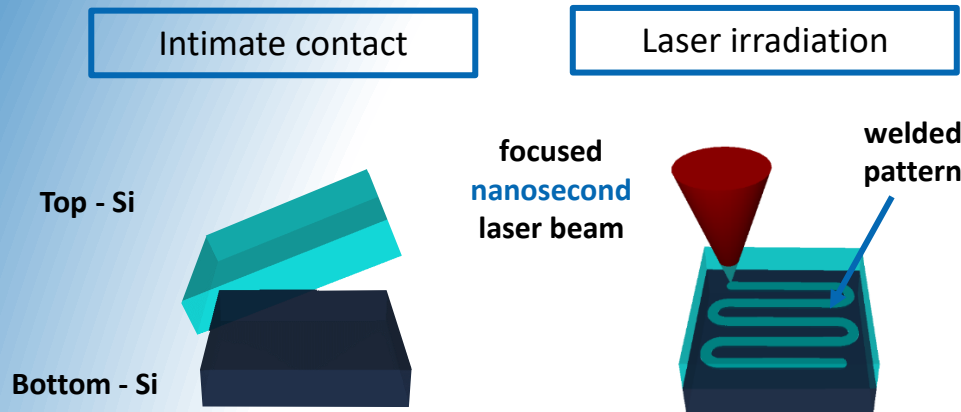
ultrashort bursts



plasma optics

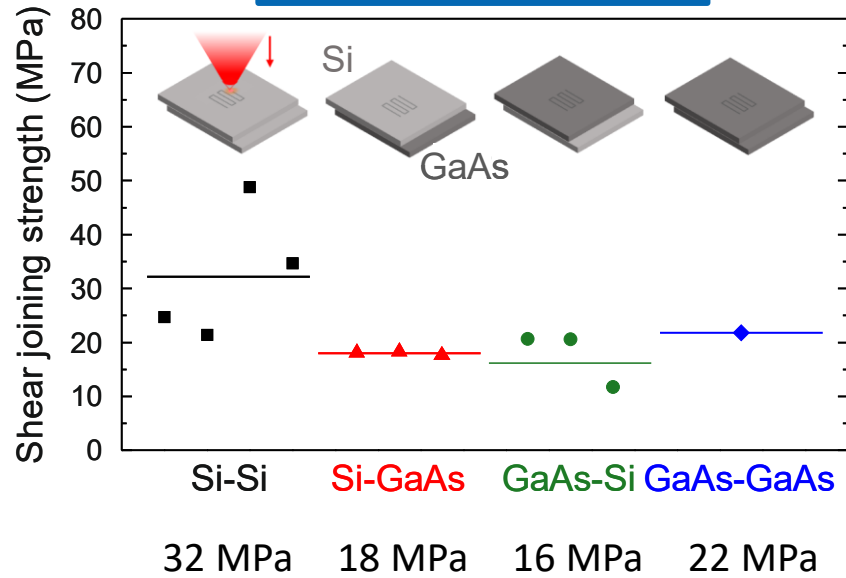


P. Sopeña, A. Wang, A. Mouskeftaras, D. Grojo, Transmission Laser Welding of Similar and Dissimilar Semiconductor Materials. Laser Photon. Rev. 16, 2200208 (2022)



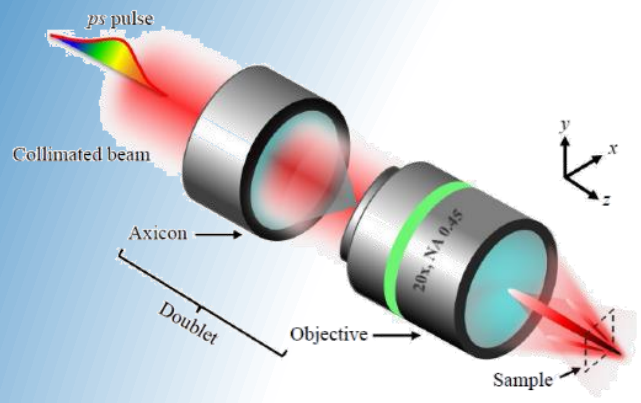
Shear joining strength (Si-Si)
32±10 MPa

Dissimilar semiconductors



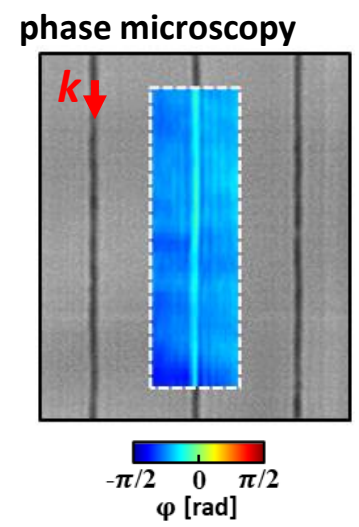
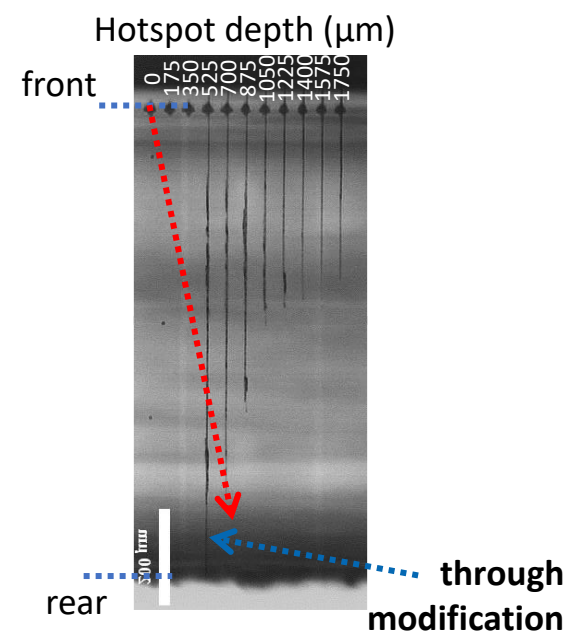
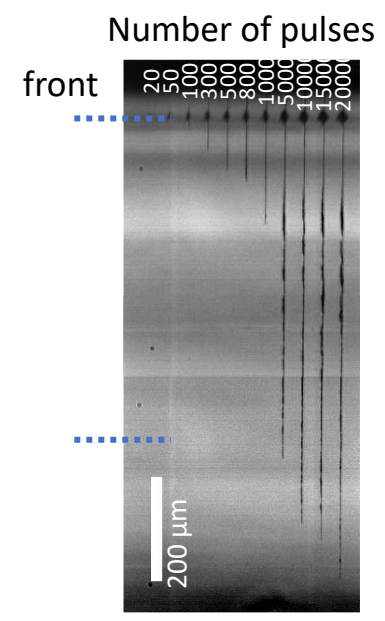
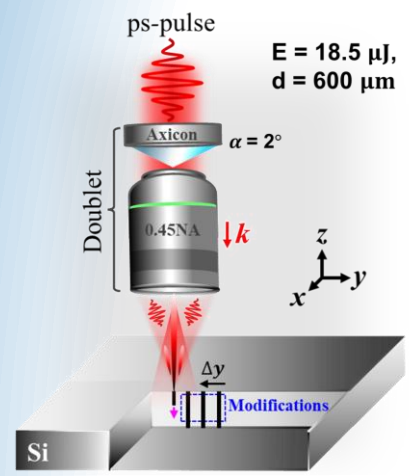
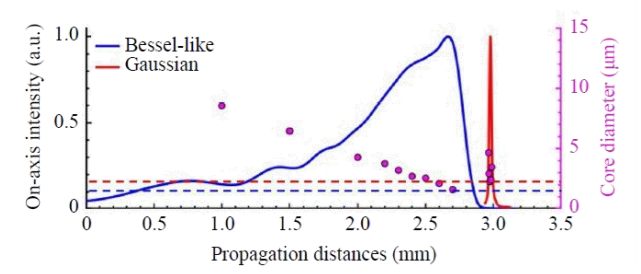
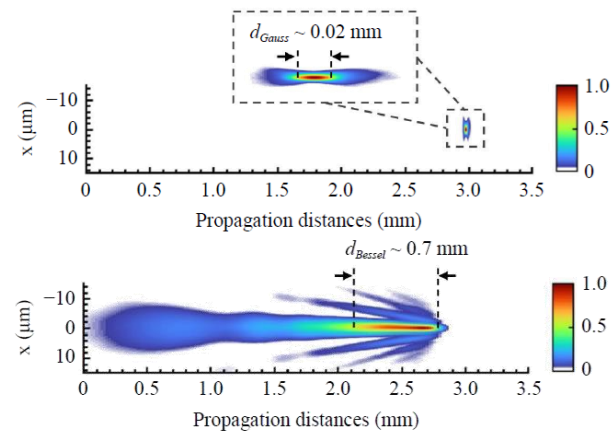
> 10 MPa

N. Ganguly, P. Sopeña, D. Grojo, Ultra-high-aspect-ratio structures through silicon using infrared laser pulses focused with axicon-lens doublets. Light: Adv. Manuf. 5, 22 (2024)



Gaussian beam

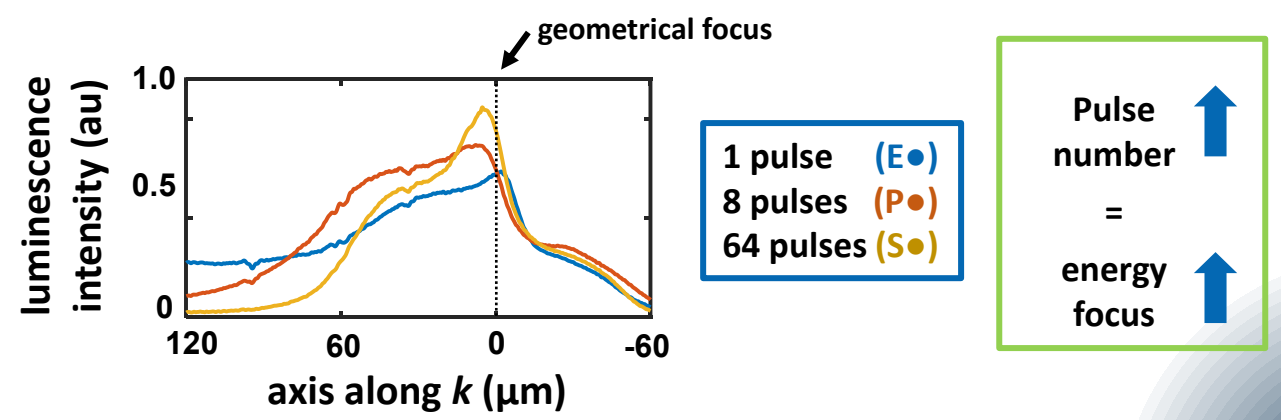
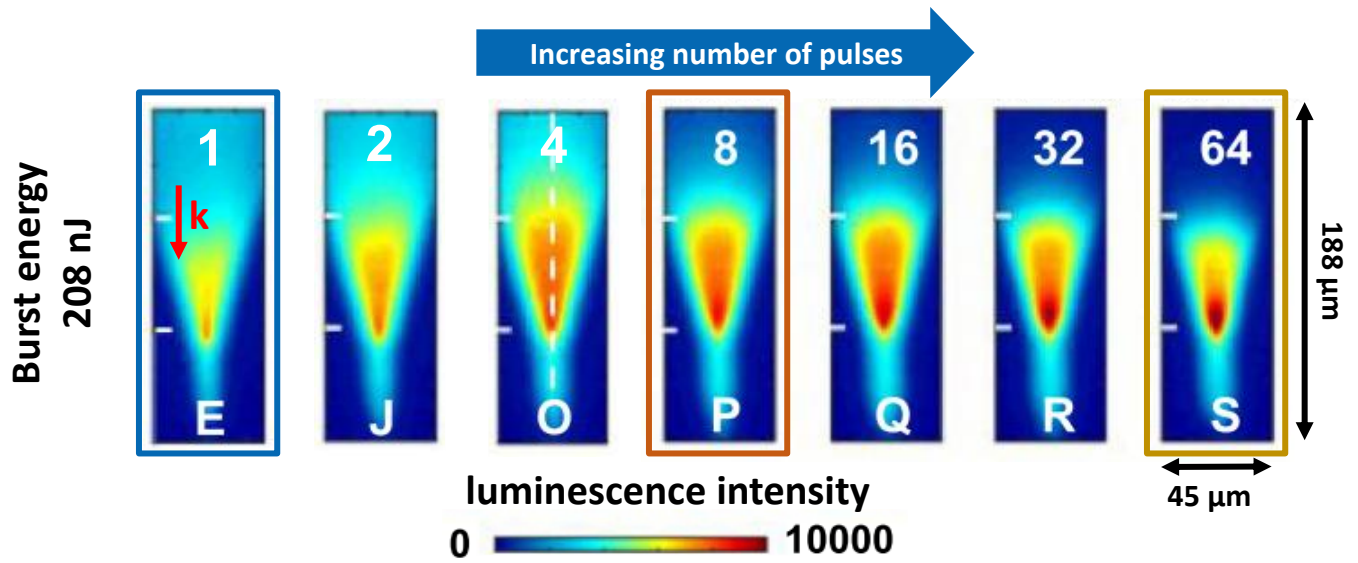
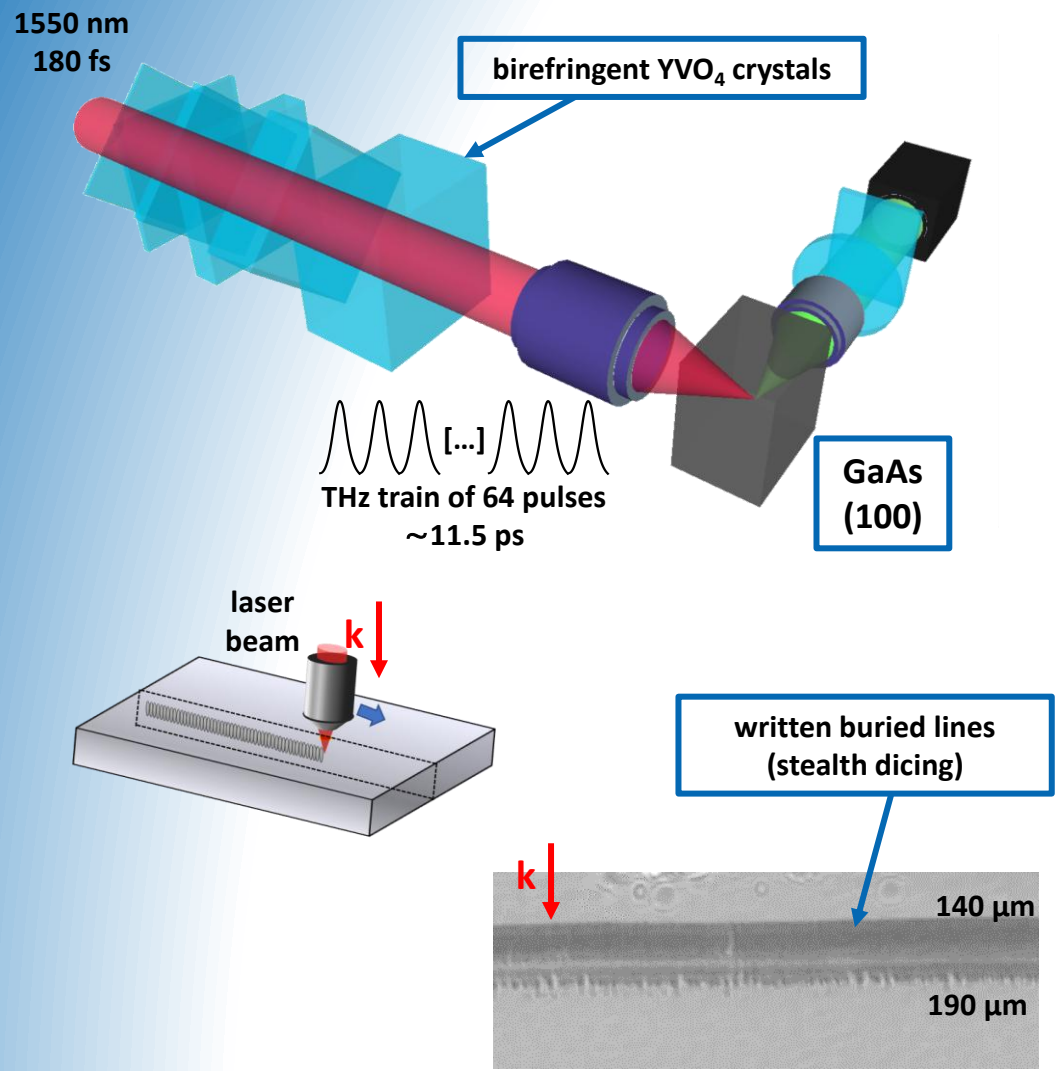
Pseudo-Bessel beam



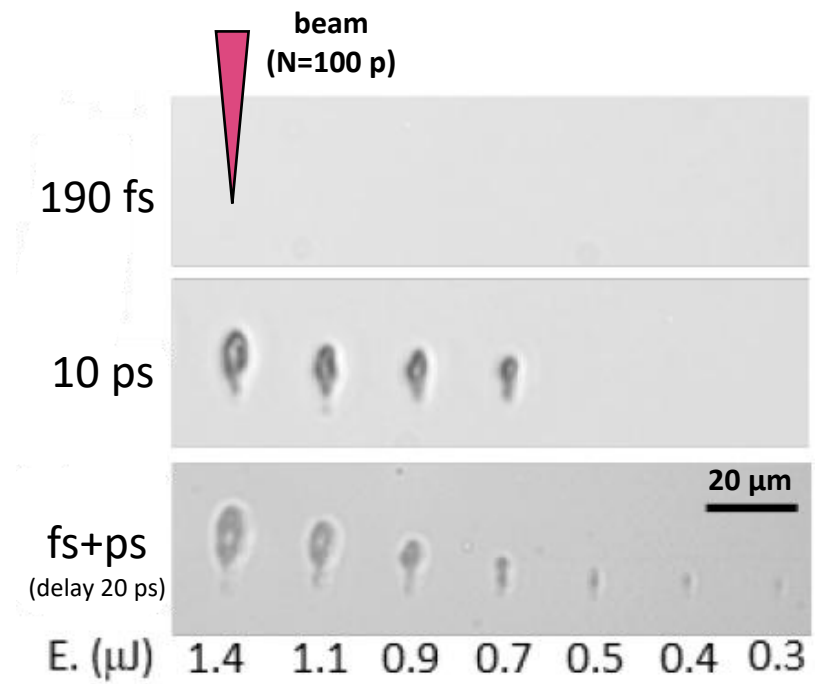
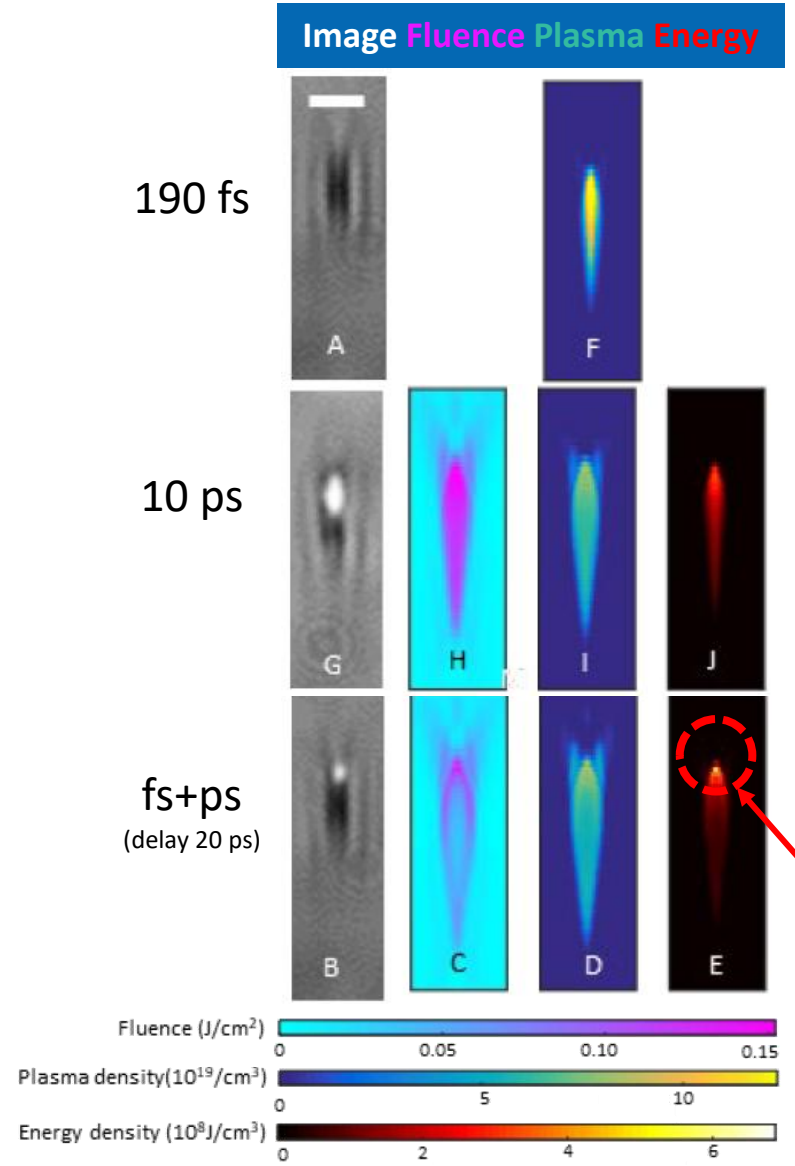
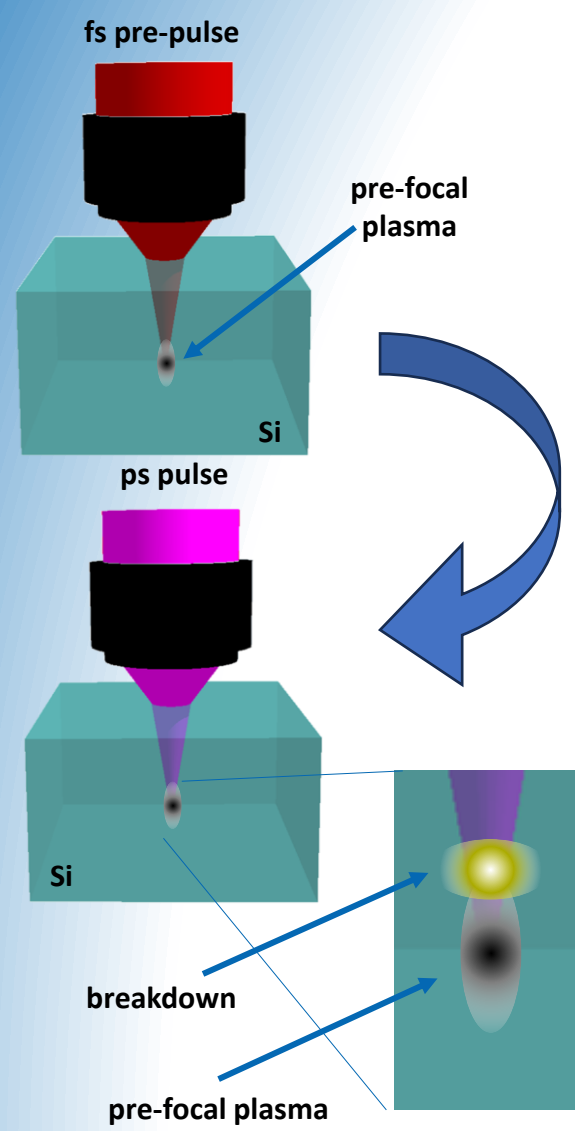
$\Delta n \sim 10^{-2}$ (1%)
Amorphous structures

Light
guiding

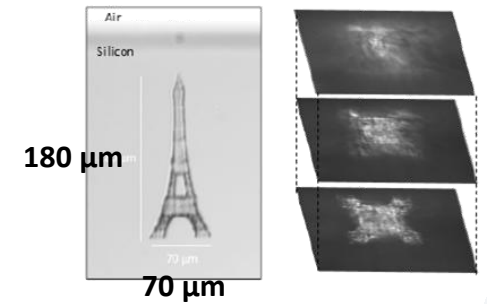
A. Wang, P. Sopeña, D. Grojo, Burst mode enabled ultrafast laser inscription inside gallium arsenide. Int. J. Extrem. Manuf. 4, 045001 (2022)



A. Wang, A. Das, V.Y. Fedorov, P. Sopeña, S. Tzortzakis, D. Grojo, In-chip critical plasma seeds for laser writing of reconfigurable silicon photonics systems, Nat Commun 16, 6733 (2025)



higher energy delivery



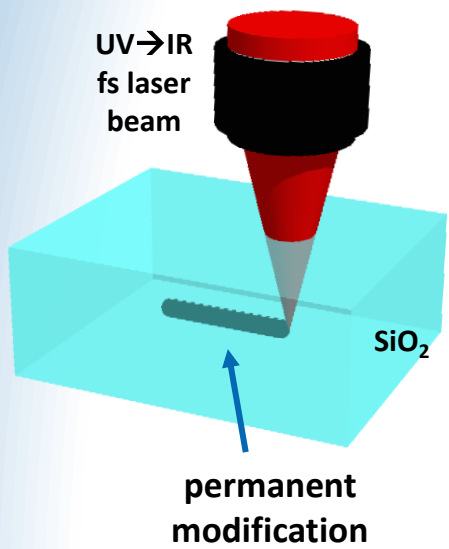
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- n: 1.45

Ultrashort pulses in dielectrics

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- Extreme intensities ($\sim 10^{15}$ W/cm²)
- Multiphoton absorption



Scattering materials

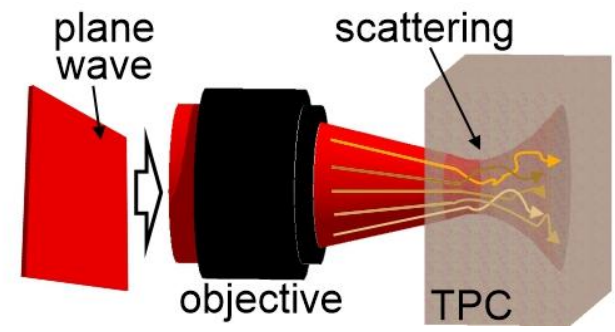
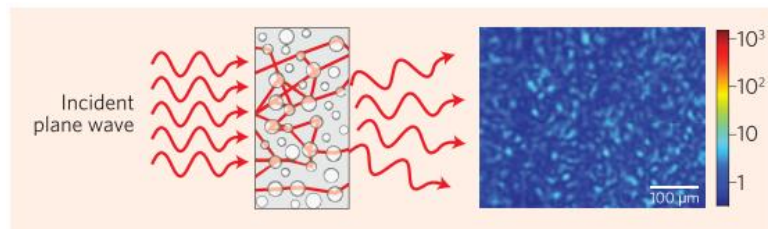
Polycrystalline ceramics

- Bandgap: ~ 5 eV
- n: 1.8

Granular polymers

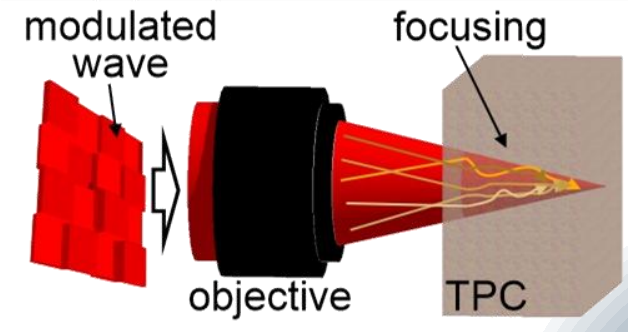
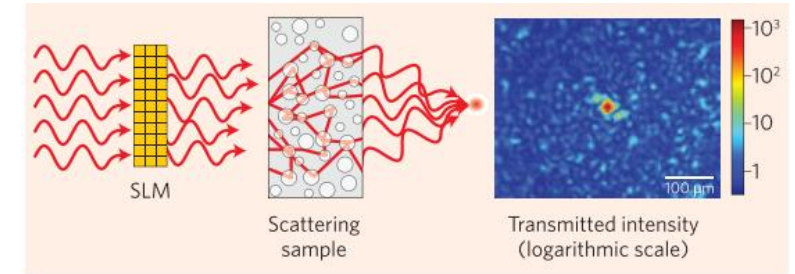
Heterogeneous structure

→ Random light propagation



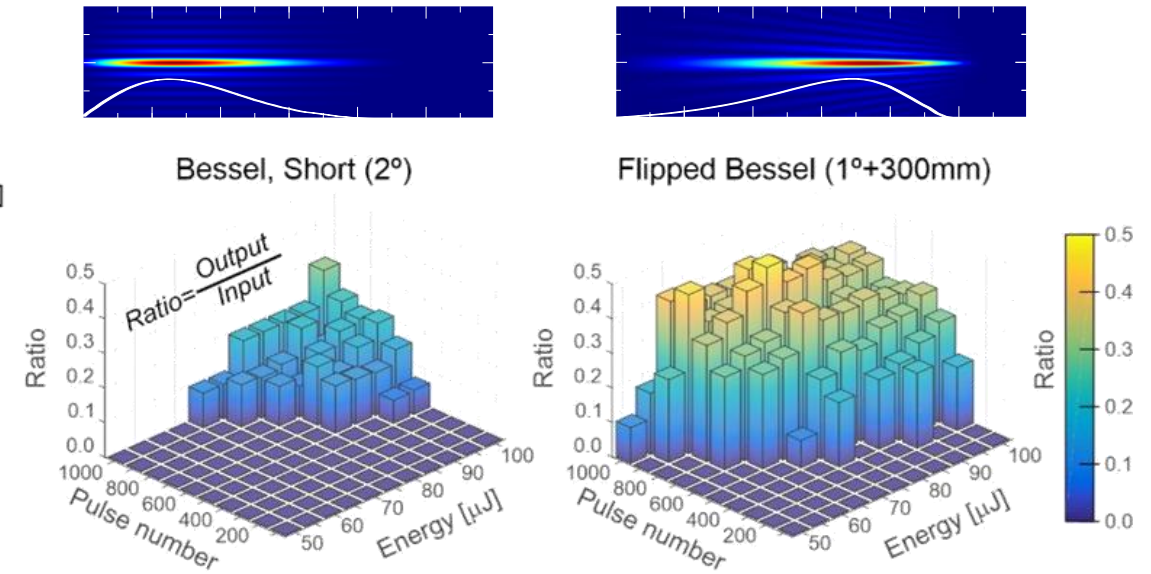
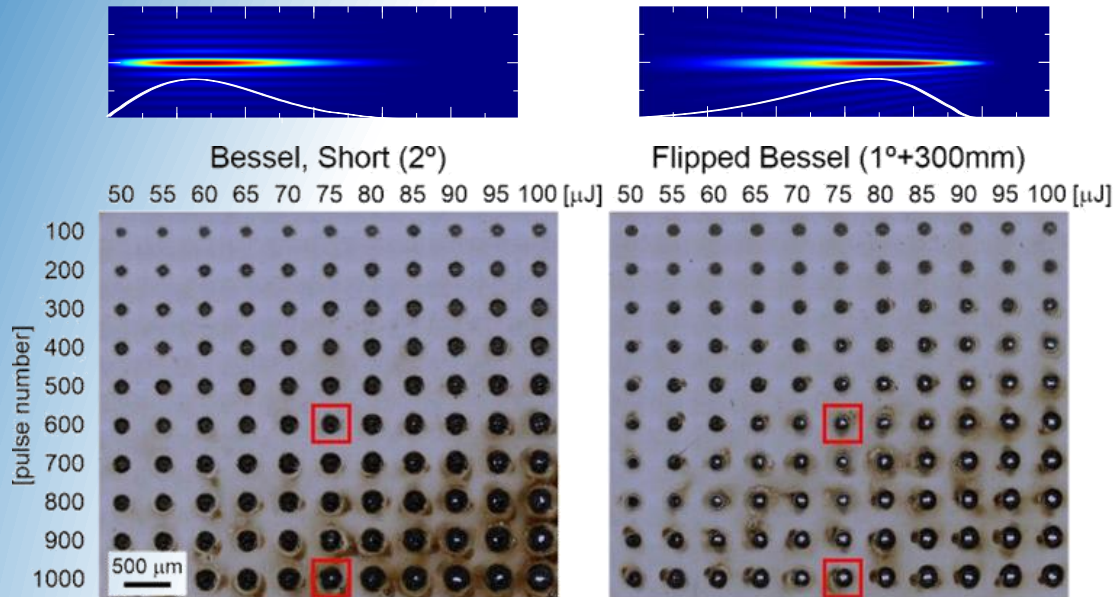
NO MODIFICATION

Phase compensation



MODIFICATION

P. Sopeña, N. Sanner, Customized flipped quasi-Bessel beams for infrared ultrafast laser drilling through scattering FR4 composite, Opt Laser Technol 192, 114037 (2025)



- Customized Bessel beams
- Improve drilling by inverting on-axis profile

→ Next: Wavefront shaping